

1752-2 1.1

## **Material Composition Declaration**

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ICP Web Site for information on IPC-1752 Standard http://www.ipc.org/IPC-175x

Form Type\* Declaration Class\* Distribute Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Infomation

Supplier Information							
Company Unique ID	Unique ID Authority	Response Date*					
00-489-5751	Dun & Bradstreet	Sat, Aug 09, 2014 02:42 AM					
Title - Contact	Phone - Contact *	Email - Contact *					
Product Ecology	801-562-7455	david.lancaster@fairchildsemi.com					
Title - Representative	Phone - Representative *	Email - Representative *					
Product Ecology	801-562-7455	david.lancaster@fairchildsemi.com					
	00-489-5751 Title - Contact Product Ecology Title - Representative	00-489-5751 Dun & Bradstreet   Title - Contact Phone - Contact *   Product Ecology 801-562-7455   Title - Representative Phone - Representative *					

Requester Item Number	Mfr Iten	n Number	Mfr Item Name		Effective Date	Version	Manufacturing Site	Weight*	UOM	Unit Type
FDP075N15A_F102	2 FDP075N	15A_F102	TO-220-3 (92.5-5-2 (G)	.5DA_AlBW)			INTERNAL SUZHOU	2.030182	g	Each
Manufacturing Process Information										
Terminal Finish	Base Alloy	J-STD-	020 MSL Rating Peak Proc		Process Body Temperature		Max Time at Peak Temperature		No Reflow cycles	
Matte Tin (Sn)	CU Alloy	Not	Applicable	С			seconds		Not Applicable	

\* Required Field

RoHS Material Composition Declaration	Declaration Type * Custom							
RoHS Directive 2011/65/EURoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium								
This document is Fairchild Semiconductor's statement regarding the directive 2011/65/EU of the European Parliament and of the council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS Recast). The content of this document is based upon information collected from Fairchild Semiconductor supply chain, manufacturing facilities and affiliates worldwide.								
The FSC part number listed above and the homogenous materials in the product are compliant with the Directive 2011/65/EU. Fairchild has implemented systems to ensure our products are compliant to environmental regulations and laws worldwide. However, not all materials in Fairchild's products may have been independently verified regarding substance content. In the event of any issues arising from information in this document, the warranty section of Fairchild's standard terms and conditions of sale shall apply, unless alternate contracts have been agreed upon in writing by both parties.								
Note: The substance content disclosed herewith is approximate and is based on various methods including, engineering calculations, supplier surveys, Material Safety Data Sheets, analytical measurements. Fairchild may update this document without notification. This statement may not include information regarding the miniscule quantities of dopant and metal materials in the electrical devices contained within the finished product. CAS numbers listed for Resin substances are generic and may contain alternate substances of similar composition.								
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substances per the definition above except for selected exemptions Sup	plier Acceptance * Accepted							
Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.								
Exemption List Version EL-2011/534/EU								
7(a)-Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85 % by weight or more lead).								

## **Declaration Signature**

David Loncosto

Supplier Signature

DAVID LANCASTER - PRODUCT ECOLOGY MANAGER

## Homogeneous Material Composition Declaration for Electronic Products

Item/SubItem Name TO-220-3 (92.5-5-2.5DA\_AIBW) (G)

Component	Material	Weight (mg)	Jig Level	Substance Category	Substance	Weight (mg)	CAS	PPM
Chip	Other inorganic materials	2.810	Supplier		Silicon	2.810	7440-21-3	1384
Die Attach	Other Nonferrous metals & alloys	1.110	А	Lead/Lead Compounds	Lead	1.027	7439-92-1	506
			Supplier		Silver	0.028	7440-22-4	14
			Supplier		Tin	0.056	7440-31-5	27
Encapsulation	Thermoplastics	518.400	Supplier		Carbon Black	5.184	1333-86-4	2553
			Supplier		Epoxy Resin	103.680	29690-82-2	51069
			Supplier		Silica, vitreous	409.536	60676-86-0	201724
Lead Frame	Copper & its alloys	1492.122	Supplier		Copper	1490.000	7440-50-8	733924
			Supplier		Iron	1.500	7439-89-6	739
			В	Nickel (external applications only)	Nickel	0.173	7440-02-0	85
			Supplier		Phosphorus	0.449	7723-14-0	221
Plating	Other Nonferrous metals & alloys	13.300	Supplier		Tin	13.300	7440-31-5	6551
Wire Bond	Aluminum & its alloys	2.440	Supplier		Aluminum	2.440	7429-90-5	1202